CLAIMS

1 1. A magnetic head comprising:

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a substrate

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a read head being fabricated upon said substrate;

a P1 pole being fabricated upon said read head;

a write gap layer being fabricated upon said P1 pole;

a P2 pole tip being fabricated upon portions of said write gap layer, wherein said P2 pole tip includes a first portion being comprised of a seed layer material and a second portion being

is formed in part from a thickness of said seed layer material portion and in part from a thickness

of said electroplated material portion.

2. A magnetic head as described in claim 1 wherein said first portion of said P2 pole tip that is comprised of said seed layer material forms a sidewall of said P2 pole tip.

3. A magnetic head as described in claim 1 wherein said seed layer material is formed with

a thickness of approximately 50 Å to approximately 500 Å, and said electroplated material is

3 formed with a thickness of approximately 100 Å to approximately 5000 Å.

1 4. A magnetic head as described in claim 3 wherein said seed layer material thickness is

approximately 250 Å and said electroplated material thickness is approximately 1500 Å.

- 1 5. A magnetic head as described in claim 3 wherein said seed layer material is comprised of
- 2 NiFe and said electroplated material is comprised of NiFe.
 - 6. A hard disk drive comprising:
 - at least one hard disk being fabricated for rotary motion upon a disk drive;
 - at least one magnetic head adapted to fly over said hard disk for writing data on said hard
- 4 disk, said magnetic head including:
- 5 a substrate;

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- 6 a read head being fabricated upon said substrate;
 - a P1 pole being fabricated upon said read head;
 - a write gap layer being fabricated upon said P1 pole;
 - a P2 pole tip being fabricated upon portions of said write gap layer, wherein said P2 pole tip includes a first portion being comprised of a seed layer material and a second portion being comprised of electroplated material, and wherein said P2 pole tip has a width dimension W that is formed in part from a thickness of said seed layer material portion and in part from a thickness of said electroplated material portion.
- 1 7. A hard disk drive as described in claim 6 wherein said first portion of said P2 pole tip that
- 2 is comprised of said seed layer material forms a sidewall of said P2 pole tip.
- 1 8. A hard disk drive as described in claim 6 wherein said seed layer material is formed with
- 2 a thickness bf approximately 50 Å to approximately 500 Å, and said electroplated material is
- 3 formed with a thickness of approximately 100 Å to approximately 5000 Å.

- A hard disk drive as described in Naim 8 wherein said seed layer material thickness is 1 9.
- approximately 250 Å and said electroplated material thickness is approximately 1500 Å. 2
- A hard disk drive as described in claim 8 wherein said seed layer material is comprised of 10.
- NiFe and said electroplated material is comprised of NiFe. 2
- A method for fabricating a magnetic head, comprising the steps of: 1
- 2 fabricating a read head upon a substrate;
- 3 fabricating a P1 pole upon said read head;
- fabricating a write gap layer upon said P1 pole;
 - fabricating a block of material upon said write gap layer, said block of material having a sidewall disposed proximate a P2 pole tip location;
 - fabricating a seed layer upon said sidewall;
 - electroplating P2 pole in material upon said seed layer, whereby a P2 pole tip is formed having a width W that is comprised of a thickness of said seed layer material and a thickness of said electroplated material;
 - 11 fabricating an induction coil proximate said P2 pole tip;
 - fabricating a P3 pole above said induction coil in magnetic interconnection with said P2 12
 - 13 pole tip; and

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- 14 fabricating an encapsulation layer above said P3 pole.
- A method for fabricating a magnetic head as described in claim 11 wherein said seed 1 12.
- 2 layer is fabricated to a thickness of approximately 50 Å to approximately 500 Å.

- 1 A method for fabricating a magnetic head as described in claim 11 wherein said
- 2 electroplated material is fabricated to a thickness of approximately 100 Å to approximately 5000
- Å. 3
- 1 A method for fabricating a magnetic head as described in claim 11 wherein said seed 14.
- layer is fabricated to a thickness of approximately 50 Å to approximately 500 Å, and wherein 2
- said electroplated material is fabricated to a thickness of approximately 100 Å to approximately 3
- 5000 Å. 4
 - A method for fabricating a magnetic head as described in claim 14 wherein said seed 15. layer is fabricated to a thickness of approximately 250 Å and said electroplated material is fabricated to a thickness of approximately 1500 Å.
- A method for fabricating a magnetic head as described in claim 11 wherein said P2 pole 16. tip is fabricated within a P2 pole tip trench having width that is wider than said width W of said <u>⊨</u> 3 P2 pole tip.
 - 1 17. A method for fabricating a magnetic head as described in claim 11 wherein said block of
 - 2 material is removed from said write gap layer following said electroplating of said P2 pole tip
 - 3 material, and said P1 pole is notched in an ion milling step.

- 1 18. A method for fabricating a magnetic head as described in claim 14, wherein said seed
- 2 layer is comprised of NiFe and said P2 pole tip material that is electroplated upon said seed layer
- 3 is comprised of NNFe.

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